





Lehigh University



telephone (215) 758-3950

Sherman Fairchild Center for Solid State Studies 161 Bethlehem, Pennsylvania 18015-3185

# **OFFICE OF NAVAL RESEARCH**

# FINAL TECHNICAL REPORT

for

1 September 1989 through 30 September 1992

for

Contract N00014-89-J-3149

R&T PROJECT: 1d14001--01



"Electrically Modifiable Nonvolatile SONOS Synapses for Electronic Neural Networks"

Name of Principal Investigator

Dr. Marvin H. White

Name of Organization

Lehigh University Sherman Fairchild Center - Bldg. 161 Bethlehem, PA 18015 (215) 758-4421

Dr. Clifford Lau Department of the Navy Office of the Chief of Naval Research 800 North Quincy Street, Code 1114SE Arlington, VA 22217-5000 (202) 696-4961

Approved for public felegae Distribution Untimited

> 1/15/35 92-29828

DEC 2

# Final Report for DARPA/ONR

by

# Marvin H. White, Chun-Yu Malcolm Chen, Margaret French and Amit Banerjee

Lehigh University Sherman Fairchild Center 161 Memorial Drive East Bethlehem, PA 18015

DTIC QUALITY INSPECTED &

Accession For
NTIS CRASI
DYEC TAB
Unamacaneed [
Justification
By
Distribution/
Availability Codes
Aveil and/or
Dict   Special
A-1

#### **Abstract**

This research addresses the implementation of an electronic element, which emulates the biological synaptic interconnection, in an artificial electronic neural system. The basic interconnection, or the weight, consists of an electrically reprogrammable, nonvolatile, analog conductance which programs at 5V levels. In addition, the fabrication technology for this synaptic interconnection is compatible with existing CMOS VLSI processes. The attractive features of this synaptic weight will be discussed in this report. Furthermore, this report examines the material needs, the device structures, the use of the synaptic weights in a two-tap weight linear adaptive neural-like circuit and the issue of integrating both the synaptic weight elements and the peripheral circuit onto a single silicon wafer.

#### 1. Introduction

The current surge of enthusiasm for neural network aims to construct systems that can learn or modify their behavior according to the environment. There are many similarities which exist between this new class of machine and human beings. One of these similarities is the massive parallelism in processing information. Parallel processing concepts are in stark contrast to the operations of modern digital computers that perform large numbers of sequential operations very rapidly and accurately.

Researchers believe the **synaptic junctions** in a neural system are the local memory sites and provide the physiological basis for the distributed parallel systems.<sup>2, 3</sup> These synapses are not only modifiable but also serve the functions of storing and transmitting information from neuron to neuron. To reduce the complex modelling required for the synaptic interconnection, the representation of the synapse has been simplified to a single ideal junction between the output of neurons (axons) and the inputs to neurons (dendrites). Synaptic modification requires information from the input and the output of the neuron in order to perform complex recognition. Therefore, the nature of the synaptic junction and the principle or algorithm which controls local organization at the neuron level become two central issues pertaining to neural networks research.

The recent interest in neural networks<sup>4, 5</sup> is a direct consequence of the programmability which is an essential feature of learning machines, associative memories, and adaptive signal processors. Programmability requires a modification of the synaptic strength in the language of neurobiology. If we seek an efficient hardware implementation of electronic neural systems, then the synapses - as well as the network itself- should be analog. Several attempts have been made to realize programmable synapses, either digitally<sup>6</sup> or with temporary storage on the input capacitance

of a MOS Transistor<sup>7, 8</sup> to alter the latter's analog conductance. The former approach stores the weight information in digital registers and thus suffers from excessive chip area and power consumption. On the other hand, although the MOS Transistor provides an analog synaptic strength (weight) in a small chip area, the weight is temporary and requires periodic refresh similar to a DRAM. Thus, this dynamic refresh approach lacks the nonvolatility and storage properties of an EEPROM cell. Researchers at Intel have reported an electrically trainable artificial neural network with floating gate device as the synaptic element.<sup>9</sup> Although the floating gate device has the property of nonvolatility, its high programming voltage requirement prevents it from being technologically compatible with scaled CMOS process.

In this research report we describe a new approach to obtain an electrically reprogrammable or modifiable synaptic weight to be used as a basic functional element in electronic neural systems.

The salient features of this network element are the following:

- Low programming voltages(5-10V) which are compatible with peripheral CMOS VLSI technology in contrast with Floating Gate approaches.
- Low power dissipation ( $< 1 \mu W$ ).
- Dynamic Range of 1000:1 (60 dB).
- Nonvolatile features which mimic biological synapses with respect to memory loss (e.g. 20% of the information available after 10 years) and reinforced learning (e.g. successive interrogation enhances memory retention).
- Small synaptic area on a VLSI chip (e.g. less then  $20\mu m^2$  for 1.25  $\mu m$  feature sizes).
- Extensive erase/write programming cycles are possible with this synapse (> 10<sup>8</sup> cycles) in contrast with Floating Gate approaches.
- Inherent radiation damage resistance beyond a total dosage of 1MRad (Co<sup>60</sup>) and 10<sup>9</sup> Rad/sec transient which is not possible with Floating Gate technology. Thus, if radiation damage resistance of neural networks is an important issue, then the SONOS devices have demonstrated success in this area.

The basic nonvolatile device structure, which we describe in this report was first introduced as a digital nonvolatile memory cell in the summer of 1987 at the IEEE Device Research Conference 10 by researchers at Lehigh University. We have had a continual involvement over a 20 year period with nonvolatile memories, beginning in the late 60's where we had programming voltages of 25V, to the late 80's with our novel 5V SONOS device structures. During this time period we introduced the use of CCD's and nonvolatile memories 11, 12, 13 in nonvolatile charge addressed memories (NOVCAM). These ideas have been employed recently for neural network circuits by researchers at

Lincoln Laboratories. 14 Our recent work recognizes the inherent analog conductance aspect of the nonvolatile SONOS memory device which makes it a perfect candidate for the modifiable synapse in an electronic neural system.

In addition to the realization of an electronic element to simulate the synaptic interconnections of a neural network, we must have a method or algorithm to change or reprogram these interconnections and, thus, alter the connectivity of the neural network. We have had experience with a particular form of an algorithm, namely, the Widrow-Hoff Least Mean Square (LMS)<sup>15</sup> error algorithm or in neural network terminology - the so-called 'delta rule'. In the late 70's we researched a CCD Adaptive Analog Signal Processor 16, 17 which realizes the 'delta rule' with CCD analog delay lines and electrically reprogrammable MNOS analog conductance weights. These weights were nonvolatile memory transistors whose analog conductance was programmed with voltages ranging from 15-25V. Our recent work on 'scaling' these programmable analog conductances has resulted in a new device structure, called the SONOS nonvolatile memory transistor, which can be reprogrammed with voltages ranging from 5-10V. This work has recently been described at the 1991 11th IEEE Nonvolatile Semiconductor Memory Workshop. 18 These voltage levels are compatible with 'scaled' CMOS VLSI technology which has 12-15V breakdown voltages for 1.25µm feature sizes. In this report we describe our recent work on the electrically reprogrammable (modifiable) SONOS nonvolatile synapse and a simple electronic neuron with 2 synaptic weights. We discuss this two-tap weight linear adaptive neuron in terms of the technology, the electrical characteristics of the synapses, and their performance in this simple test vehicle - a 'delta rule' adaptive signal processor.

# 2. Technology and Characterization of the SONOS Synaptic Weight

The programmable synapse is the result of an ongoing effort at Lehigh University to 'scale' the programming voltages required to alter the analog conductance of a nonvolatile memory transistor with a multi-layer (oxide-nitride-oxide) gate insulator as shown in Fig. 1. Recent efforts in scaling this device have resulted in a SONOS (Silicon/Blocking Oxide/Nitride/Tunneling Oxide/Silicon) nonvolatile memory transistor which is electrically reprogrammable at CMOS voltage levels. Typically, the tunneling oxide is 15-25Å, the storage nitride is 50-100Å and the blocking oxide is 35-50Å. Fig.2 shows the Transmission Electron Microscope (TEM) photograph of the cross sectional view of the SONOS transistor. This device is similar to a SNOS transistor except for the addition of the blocking oxide which is used to inhibit injection of carriers from the polysilicon gate electrode

and also to improve the memory retention by prohibiting the transfer of stored charge from the nitride to the gate electrode. As a result, the blocking oxide permits the entire dielectric sandwich to be scaled to dimensions where programming voltages ranging from 5-10 V are possible.

When the SONOS device is subjected to a positive (or negative) programming pulse, electrons (or holes) are injected into the silicon nitride layer by means of tunneling across the thin tunnel oxide. The injected charges are trapped by the silicon nitride and, thus, shift the threshold voltage positively (or negatively). The threshold voltage of a SONOS transistor can be written as

$$V_{TH} = \phi_{GS} - \frac{Q_f}{C_{eff}} + \left(\frac{x_{ob}}{\varepsilon_{ox}} + \frac{x_n - x}{\varepsilon_N}\right) Q_N + 2\phi_B + \frac{\sqrt{4 \varepsilon_{si} q N_B \phi_B}}{C_{eff}}$$
(1)

where  $\phi_B$  is the bulk potential,  $\phi_{GS}$  is the gate to semiconductor workfunction,  $Q_f$  is the fixed charge at the tunneling oxide-silicon interface,  $\epsilon_{ox}$  and  $\epsilon_{N}$  are the dielectric permittivities of the oxide and nitride,  $\epsilon_{si}$  is the dielectric permittivity of the bulk silicon,  $\mathbf{x}_{ot}$  is the tunnel oxide thickness,  $\mathbf{x}_{ob}$  is the blocking oxide thickness,  $\mathbf{x}_{n}$  is the nitride thickness,  $\mathbf{x}$  is the charge centroid in the insulator, and  $Q_{N}$  is the charge stored in the nitride,  $N_{B}$  is the bulk doping density, and

$$C_{\text{eff}} = \frac{\varepsilon_{\text{ox}}}{x_{\text{ot}} + \frac{\varepsilon_{\text{ox}}}{\varepsilon_{\text{N}}} x_{\text{n}} + x_{\text{ob}}}$$
(2)

We assume the tunnel oxide and blocking oxide have the same dielectric permittivity; even though, it is known that the tunnel oxide is silicon rich and the blocking oxide is an oxynitride. The values of the charge centroid  $\bar{x}$  and the variable charge stored in the nitride  $Q_N$  will change as the device is written or erased. The analog conductance of the SONOS synaptic weight is given as

$$g_{ds} = \overline{\mu}_{eff} \frac{W}{L} C_{eff} (V_{GS} - V_{TH})$$
(3)

where  $\overline{\mu}_{eff}$  is the effective carrier mobility,  $V_{GS}$  is the read voltage, and  $V_{TH}$  is the electrically modifiable threshold voltage given in equation (1). Therefore, there are two ways which the analog channel conductance can be altered: (1) change the value of  $V_{GS}$  or (2) change the value of  $V_{TH}$  by altering the stored charge,  $Q_N$ , in the nitride. In our study, the latter approach is chosen.

The SONOS transistors have been characterized for their memory properties with the test station described by Roy et. al. 19. This test station allows one to take both erase/write and retention

measurements. To investigate the memory loss/retention properties of the synaptic weight element, retention measurements are taken. The retention characteristics are obtained by applying positive (negative) five volts to the gate for 10 seconds to place the device in the write (erase) state and then measuring the turn-on voltage after a varying delay time. The turn-on voltage is related to the threshold voltage by

$$V_{\rm T} = V_{\rm TH} + \sqrt{\frac{2I_{\rm DS}}{\beta}} \tag{4}$$

with  $I_{\mbox{\footnotesize DS}}$  as the forced drain to source current during measurement and

$$\beta = \overline{\mu}_{\text{eff}} \left( \frac{W}{L} \right) C_{\text{eff}} \tag{5}$$

where W is the width of the transistor, L is the length of the transistor, and  $\overline{\mu}_{\rm eff}$  is the effective mobility. The effective mobility is the bulk mobility reduced by Coulombic and surface scattering of carriers in the inversion layer. This mobility is influenced by the gate and substrate voltages. For a SONOS transistor, retention measurements indicate that greater than 20 percent of the memory window remains after a projected 10 year delay time as shown in Fig. 3. The erase/write measurements indicate the programming speed of the synaptic weight element. To measure the writing (erasing) speed, negative (positive) five volts are applied to the gate for 10 seconds to place the device in the erase (write) state. Then, positive (negative) five volts are applied to the gate with varying pulse widths and the turn-on voltage is measured after each pulse width. The erase/write characteristics of the SONOS memory transistor are shown in Fig. 4. A wide dynamic range is one of the essential properties for the synaptic weight element, and Fig. 5 illustrates a 60 dB in dynamic range after  $\pm 5$ V programming for the SONOS synaptic weight. In addition, a recent study in reliability has demonstrated the inherent resistance of the SONOS memory transistor to radiation damage ( $\delta V_{TH} = 0.1$ V, with  $V_{GS} = +5$ V at 1MRad Co<sup>60</sup> radiation).<sup>21</sup>

## 3. Single-level Linear Adaptive Neuron

We have incorporated the SONOS synaptic weights into a single-level linear neuron-like circuit using a Widrow-Hoff's delta learning rule. 15 The circuit is built with a hybrid breadboard of CMOS components for the control logic and the algorithm implementation and the SONOS nonvolatile memory transistors to demonstrate the voltage level compatibility of both SONOS and CMOS technologies. Many researchers believe that the neural system is made up of several layers'

of neurons and Fig. 6 shows the multi-layer architecture of an artificial neural network. The first layer of neurons, the input layer, can be best thought as the sensory neurons in a human body. The weight connections between the input layer and the middle hidden layer are normally considered to be feedforward and fixed. On the other hand, the weight connections between the middle hidden layer and the output layer are considered to be feedback in nature. Our work has concentrated on the implementation of two neurons in the hidden layer and one output neuron as highlighted in the figure.

Fig. 7 shows the block diagram of the single-level linear adaptive neuron. A desired response (or external teacher), d(m), is presented to the neuron as the training signal. If the output of the linear adaptive neuron is not trained, then there exists a mismatch between the output of the linear adaptive neuron, y(m), and the desired response, d(m),

$$\varepsilon(m) = d(m) - y(m) \tag{6}$$

where  $\varepsilon(m)$  is the error generated. This error is then used by a learning algorithm, namely the Clipped-data Least Mean Square Error algorithm, to minimize the error generated and thereby training the neuron to the correct response. This single-level linear adaptive neuron has two tap weights, each weight composed of two SONOS analog electrically reprogrammable conductances as shown in Fig. 8. Since the synaptic weight may be either positive or negative in value, we have chosen a differential weighting scheme. If the analog conductance connecting the positive summing path to the differential operational amplifier is greater than the analog conductance connecting the negative summing path to the differential operational amplifier, then the weight is positive in value. On the other hand, if the opposite case is true, then the weight is negative in value. A positive weight value corresponds to an excitatory synaptic strength and a negative weight value corresponds to an inhibitory synaptic strength.

In operation, the input signal x(t) is passed through a switched capacitor analog delay line where the input signal is sampled and delayed to create four tapped signal outputs  $x_0(m)$ ,  $x_1(m)$ ,  $x_2(m)$ , and  $x_3(m)$ . These tapped signals multiply to their corresponding programmable weights  $W_0$ ,  $W_1$ ,  $W_2$ , and  $W_3$ , and the result is summed linearly at the summing amplifier. The output y(m) can be expressed as

$$y(m) = \sum_{k=0}^{3} W_k(m) \cdot x_{m-k} \tag{7}$$

where m is the time index and k is the spatial index. A correlated double sampling technique<sup>22</sup> is employed in the circuit to remove the unwanted noise and offset voltages introduced by the operational amplifiers and switching circuits. The linear adaptive neuron is configured to perform a Widrow-Hoff's delta rule as

$$W_k(m+1) = W_k(m) + \Delta W_k(m) \tag{8}$$

where  $\Delta W(m)$  is the incremental weight to be calculated by the clipped-data least mean square error (C-LMSE) algorithm<sup>23</sup>:

$$\Delta W_{\nu}(m) = 2\mu |\varepsilon(m)| \cdot Sgn[\varepsilon(m)] Sgn[x(m-k)]$$
(9)

where  $\mu$  is the convergence factor. Compared to the regular Least Mean Square Error algorithm, the input signal amplitude is clipped in the learning algorithm. This algorithm eliminates the usage of a four quadrant multiplier needed for the LMS error algorithm. The sign multiplication in the incremental weight calculation is essentially an Exclusive OR operation and the output of the Exclusive OR gate controls the path of proper gate programming voltage for the SONOS synaptic weight. If the convergence factor is small, then the system will minimize the misadjustment caused by the variance of the weights; however, this also results in a long convergence time. Conversely, if we choose to use a larger convergence factor, then the convergence time of the system is shortened with the penalty of larger misadjustment. The backpropagating error is used to calculate the adjustments to minimize the system error as shown in equation (9). Once the error is minimized, the system is said to be in its steady state condition<sup>24</sup> where the output of the system, y(m), is the best match of the training signal, d(m), or the 'external teacher'.

The incremental weight update is essentially a cross correlation between the error and the clipped input data vectors. The update stops when the two vectors become orthogonal. Sometimes, the network may be overcorrected initially, however, the error will be quickly minimized by the learning algorithm and the system reaches its desired response. The digital delay line provides the sign information of the input to the learning algorithm. A special steering network is designed to switch the proper programming voltages to the gate terminals of the SONOS transistors once the

incremental weights are calculated.

#### 4. Experimental Results

There are two main types of characteristics from which the electrical performance of the linear adaptive neuron can be evaluated. The first characteristic, namely the output and training signals versus time characteristics, gives the information on how well the output signal approximates the training signal especially in the phase relationship between these two signals. The second characteristic, namely the error signal versus time characteristics, shows how fast the linear adaptive neuron adapts before it reaches its minimum error. A typical output and training signals versus time characteristic consists of two parts: the initialized and the adapted part. In the initialized part, the weights are first initialized to a known state (either the fully positive or the fully negative state) and then the weights are subjected to a reading voltage to read out the weight information and the output signal and the training signal are compared and recorded. The linear adaptive neuron is then allowed to adapt itself to the training signal and the results are shown in the adapted part of the characteristics. Figure 9 shows the output and training signal versus time characteristic.

A typical error signal versus time characteristic is obtained with initialized weight values and monitoring the error signal with time. Our observation indicates the weight initialization scheme affects the convergence behavior of the linear adaptive neuron. This phenomenon is attributed to the nonsymmetric erase and write characteristics of the SONOS transistor. Therefore, one weight initialization scheme may require more erase action taking place than another weight initialization scheme, causing a difference in convergence characteristics. Figures 10 shows a typical error versus time characteristic.

#### 5. Technical Achievements

During the period of investigation, several technical achievements have been accomplished. Since the programming characteristics of the SONOS synaptic weight elements strongly govern the performance of the integrated solid-state linear adaptive neuron, the optimization of the SONOS synaptic weight element becomes one of the key issues of this research effort. We have started our research with a SONOS device structure of 20Å of tunneling oxide, 96Å of nitride, and 25Å of blocking oxide. The cross-over time for this structure is 1 second. After examining the programming behavior of the SONOS structure mentioned above, we have decided to scale down the nitride

thickness and increase the blocking oxide thickness. This scaling scheme is based on the analysis which promises higher programming field across the multi-layer dielectrics and better charge retention in the nitride due to the elimination of the carrier injection from the gate terminal as well as the carrier tunneling to the gate terminal. The scaling effort has produced a new device structure with the programming speed improvement of one order of magnitude compared to the previous version. We have then incorporated these new SONOS synaptic weight elements in the linear adaptive neuron and observed a corresponding one order of magnitude improvement in convergence speed. Therefore, the direct relationship between the programming characteristics of the SONOS synaptic weight elements and the performance of the linear adaptive neuron has been proven experimentally.

Encouraged by the sucess in scaling down the device dielectric structure, we have extended our research effort in fabricating two new sets of devices. One set of devices have the dielectric thicknesses similar to Nozaki et. al. 25 with 18Å tunneling oxide, 49Å nitride and 40Å of blocking oxide. The other set of the devices have an ultra-thin tunneling oxide of 11Å, 49Å of nitride and 40Å of blocking oxide. For the first time, the ultra-thin tunneling oxide SONOS devices have been successfully tested and reported. The programming characteristics of the ultra-thin tunneling oxide indicate a much better improvement over those published in the literature and the result is shown in figure 10. In addition, a novel device structure is currently under investigation, namely the buried channel SONOS device structure. This structure has demonstrated better programming speed as well as improved retention time compared to the conventional surface channel SONOS device with similar dielectric dimensions. A typical buried channel SONOS device programming characteristic is shown in figure 11.

Furthermore, a theoretical analysis of the convergence behavior with a variable convergence factor has been developed. The variable convergence factor scheme is a direct result of using the SONOS memory transistors as the reprogrammable synaptic weight elements. The convergence factor initially starts with a large value, which accelerates the convergence process. As time progress, the convergence factor reduces its value and aids the linear adaptive neuron converging to its optimum steady state condition. The analysis is composed of two separate models: ERASE/WRITE tunneling model and Fowler-Nordheim tunneling model. A computer software has been written to simulate the convergence behavior of the linear adaptive neuron with the incorporation of variable convergence factor. Since the device model is physically based, the input

variables of the simulation software are actual physical device parameters of the SONOS synaptic weight elements.

A fully computer controlled data acquisition system is an invaluable tool for SONOS synaptic weight element characterization. Previously, the measurement system required the operator to manually set up the measurement sequence and hand-recorded the data obtained. An automated data acquisition system enables the user to set up measurements, analyze the data, and extract device parameters, all under the control of one console. The automated data acquisition system has been designed, constructed and fully tested. A block diagram of the system is depicted in figure 12 and the schematic of the HPIB command/data interpreter is shown in figure 13. The system is composed of an HP 9836 technical computer served as the controller, a HPIB (HP Interface Bus) command/data interpreter which interfaces with the computer and sets up the erase/write/read circuit and the pattern generator, a digital storage oscilloscope responsible for capturing the measured result and transmitting the data back to the computer for analysis. In addition, the wafer can be placed in an automatic wafer prober with temperature controller to perform wafer level temperature testing. A software control routine has been written to coordinate the instruments in the system. The source code for control routine can be provided upon request.

Integration of the linear adaptive neuron onto a single silicon wafer is one of the mail goals of our research efforts. We have acquired a computer aided design software package, developed by the Mentor Graphics Corporation, and implemented on our SUN Sparc Workstations. The first task of using this software is to develop a technology file geared to the fabrication sequence of the Microelectronic Research Laboratory at Lehigh. In addition, the technology file must accommodate both the conventional CMOS process and the Nonvolatile Semiconductor Memory (NVSM) technology for the SONOS synaptic weight element implementation. Novel processing steps such as buried channel implants, semiconductor implanted resistor are also incorporated into the technology file. Since we are creating analog ASICs, area and power consumption must be minimized. We have adopted a hierarchical design approach from basic functional cell design up to the entire integrated solid-state linear adaptive neuron design to ensure the minimization of power and area consumption. The design of the entire integrated adaptive neuron has been completed and the process of making the masks containing the design is currently undergoing.

The integrated adaptive neuron is composed of five main cells, namely, the clock module, the

analog delay line module, the steering network module, the summing module and the algorithm module. The clock module generates all the controlling signals and thus synchronizes all the operations of the linear adaptive neuron to a master clock. The analog delay line module utilizes switched capacitor scheme to delay the input signal. The steering network module is responsible to direct proper programming voltages to the SONOS synaptic weight elements during adaptation. The summing module sums up the weighted input signals and removes the unwanted noise from the system. The algorithm module uses the information from the summing module to produce programming voltages for the steering network module according to the clipped data Least Mean Square error algorithm. A complete layout design is shown in figure 14. A printed circuit board version of the integrated solid-state linear adaptive neuron is also designed and implemented. The schematic of the PCB version of the linear adaptive neuron can be furnished upon request.

We believe we have advanced the understanding of the how the SONOS synaptic weight elements can be used in the implementation of the neural network. In addition, we have demonstrated success in scaling of the SONOS nonvolatile memory transistors and thus provided a guideline for future scaling of the SONOS devices. We have also contributed to the state of the art in the implementation of the artificial neural networks with our design of integrated solid-state linear adaptive neuron. Under the support of this project, numerous papers have been accepted and a list of publications is attached in appendix B.

#### 6. Conclusions

The SONOS nonvolatile memory transistor has been shown to be an ideal electronic element for the electrically reprogrammable analog conductance in an artificial neural network. We have demonstrated the attractive features of this synaptic weight for the use of large neural network systems, for instance, low programming voltage (5-10V), low power dissipation( $<1\mu$ W / synapse), small chip area (estimated  $20\mu$ m²/ weight cell for a 1.2  $\mu$ m feature size), a dynamic range of 60 dB, good memory retention (20 % window at a projected 10 years period), and endurance beyond  $10^7$  erase/write cycles. In addition, the SONOS synaptic weight has inherent resistance to radiation damage ( $\Delta V_{th} = 0.1V$ , with  $V_{gs} = +5V$  at 1MRad Co<sup>60</sup> radiation). We have been continuing our efforts in optimizing the modifiable synaptic weights to provide better electrical characteristics for neural network applications.

We have also incorporated the SONOS synaptic weights into a single-level two tap linear

adaptive neuron employing a Widrow-Hoff's delta learning rule. The combination of CMOS control circuits and SONOS synaptic weights has demonstrated the feasibility of integrating these two technologies onto a single silicon wafer. The initial results are encouraging and promising and provide insight and direction into the integration of these two technologies to realize large artificial neural network systems.

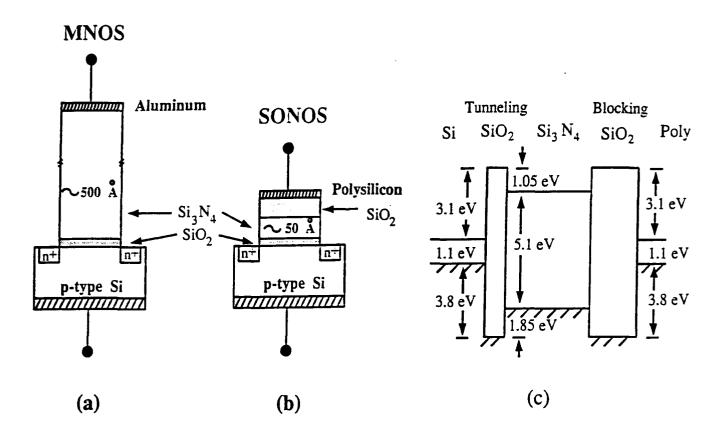


Figure 1. Cross Sectional View of the (a) MNOS (b) SONOS Electrically Modifiable Synaptic Weight (c) SONOS Ideal Energy-Band Diagram

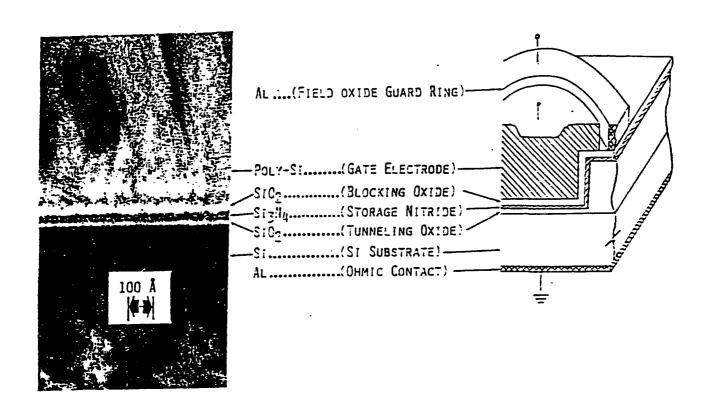


Figure 2. TEM Photomicrograph of the SONOS Synaptic Weight

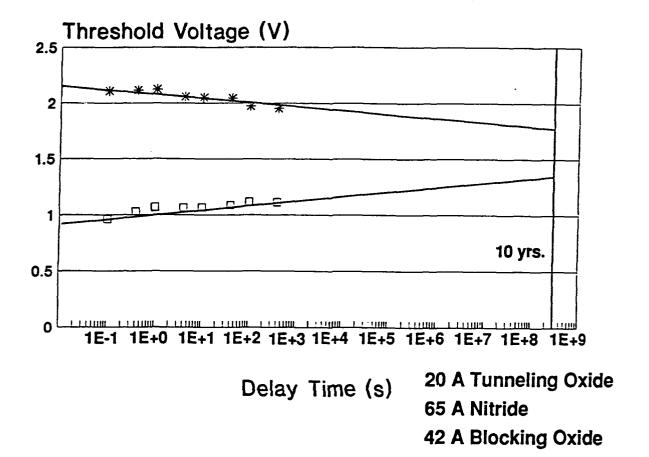


Figure 3. Retention Characteristics of a Modifiable SONOS Synaptic Weight

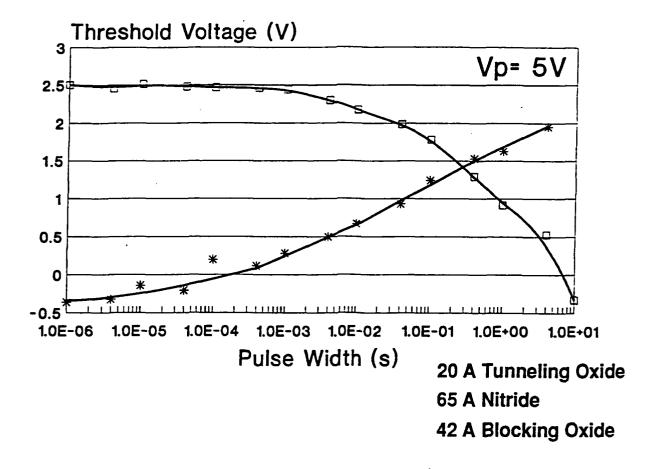


Figure 4. Erase/Write Characteristics of a Modifiable SONOS Synaptic Weight

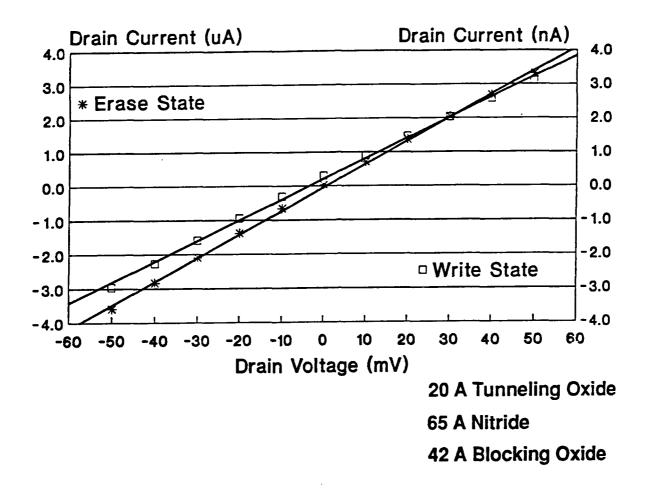


Figure 5. Dynamic Range of a SONOS Synaptic Weight After Programming

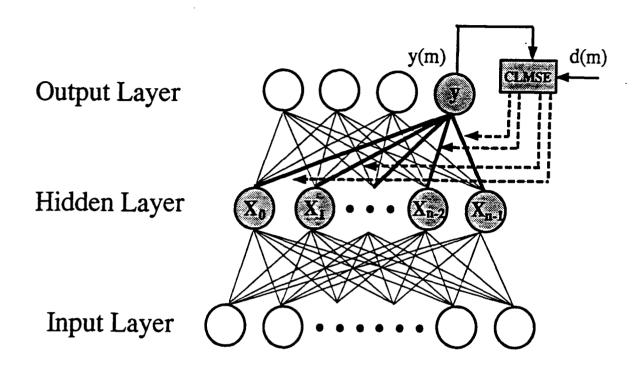


Figure 6. Conceptual View of Multi-layer Artificial Neural Network Architecture Incorporating the Single-Level Linear Adaptive Neuron

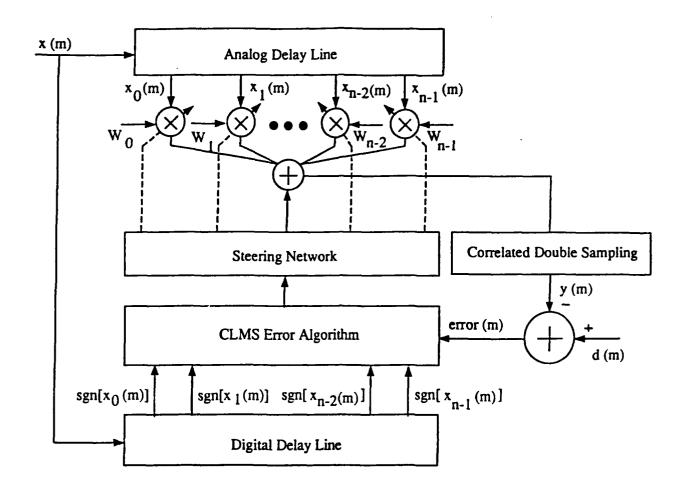


Figure 7. Block Diagram of a Single-level Linear Neuron

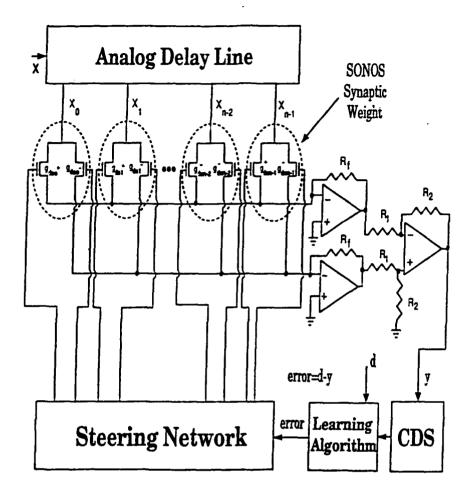


Figure 8. Electrical Implementation of the Synaptic Weights

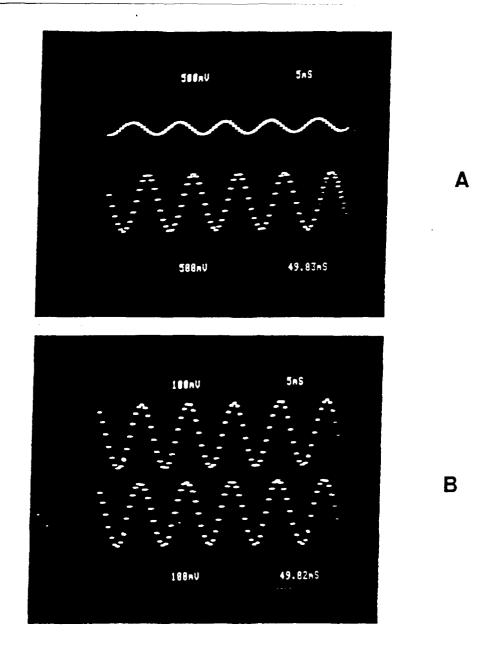
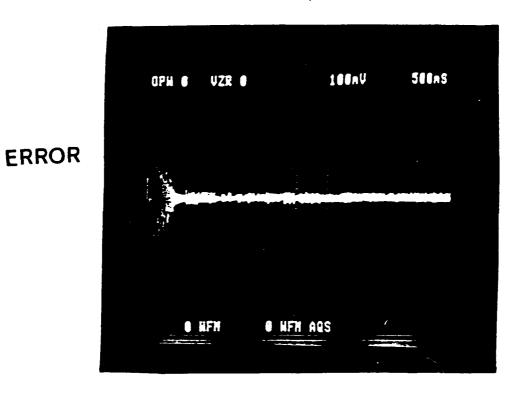


Figure 9. Output and Training Signals versus Time Characteristics of a Two Tap Weight Linear Adaptive Neuron (a) Initialized (b) Adapted



# TIME

Figure 10. Error Signal versus Time Characteristics of a Two Tap Weight Linear Adaptive Neuron

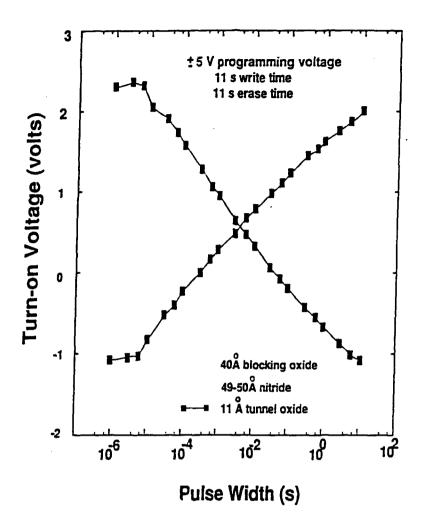


Figure 11. Programming Speed of the Newly Made Synaptic Weight Element with 11 Angstrom of Tunneling Oxide

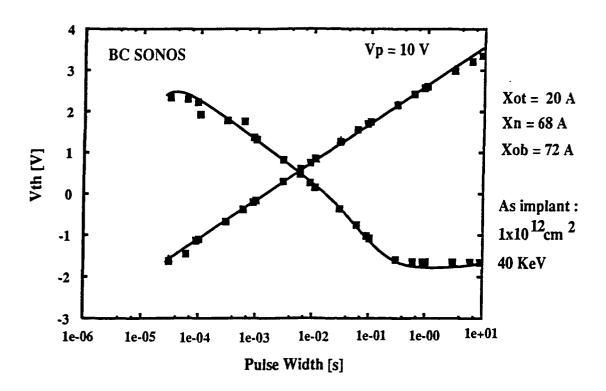
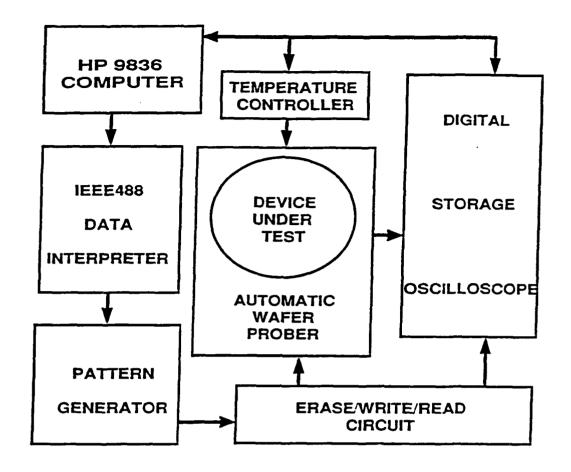


Figure 12. Programming Speed of the Novel Buried Channel SONOS Synaptic Weight Element



Automated setup for memory characterization

Figure 13. Block Diagram of the Automated Data Acquisition System

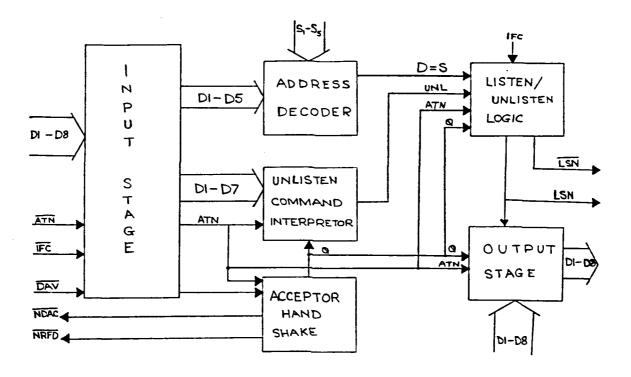


Figure 14. Schematic Diagram of the HPIB Command/Data Interpreter

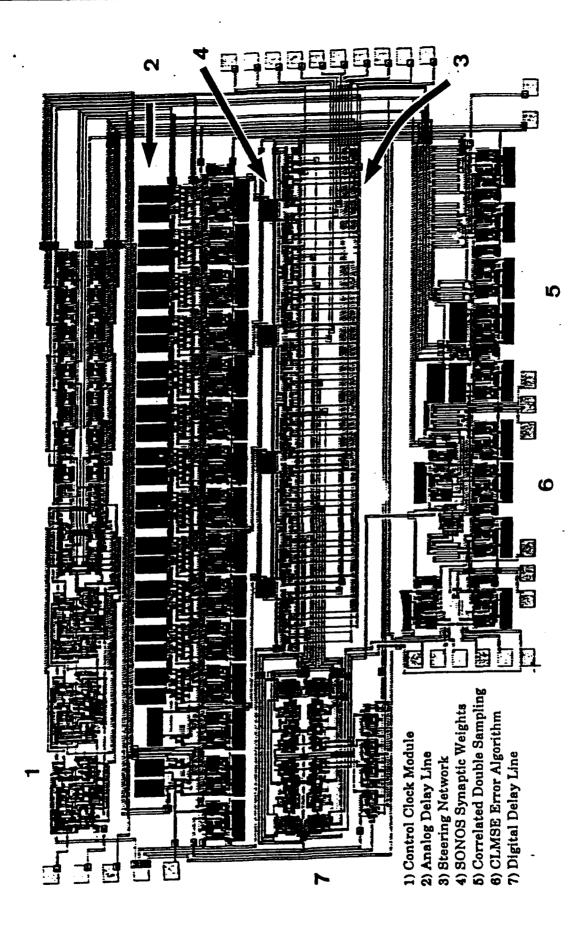


Figure 15. Complete Layout of the Integrated Solid-State Electronic Linear Adaptive Neuron

## Appendix A

# CMOS/NVSM Fabrication Sequence with Novel Buried Channel Devices

- Starting Material 3 in p-type 2-3 Ohm/cm
- N-Well Implant Formation
  - 1. RCA Clean
  - 2. Wet Oxidation for 1000 Å, 950 °C, 25 min
  - 3. Photoresist Application
  - 4. Prebake, 98 °C, 30 min
  - 5. Mask Level NW
  - 6. Photoresist Development
  - 7. Postbake, 120 °C, 30 min
  - 8. BHF Etch, 10:1, 2 min
  - 9. Implant, Phosphorus, 4.8×10<sup>12</sup>, 100KeV
  - 10. Plasma Photoresist Strip (Oxygen)
  - 11. Photoresist Stripper
  - 12. Dry Oxidation, 500 Å, 1200 °C, 5 min
  - 13. Implant Anneal, 1200 °C, 240 min

#### • Active Device

- 1. RCA Clean
- 2. LPCVD Nitride, 200mTorr, 10:1 ratio, 1000 Å, 54 min
- 3. Photoresist Application
- 4. Prebake, 98 °C, 30 min
- 5. Mask Level AD
- 6. Photoresist Development
- 7. Postbake, 120 °C, 30 min
- 8. Plasma Etch Nitride (CF<sub>4</sub>)
- 9. Photoresist Stripper

#### • Channel Stop Implant

- 1. Photoresist Application
- 2. Prebake, 98 °C, 30 min
- 3. Mask Level FI
- 4. Photoresist Development

- 5. Postbake, 120 °C, 30 min
- 6. Implant, BF<sub>2</sub>,  $5 \times 10^{11}$ , 145KeV
- 7. Plasma Photoresist Strip (Oxygen)
- 8. Photoresist Stripper
- 9. RCA Clean
- 10. Wet Field Oxidation, 6500 Å, 1100 °C, 60 min
- 11. BHF Etch, 10:1, 1 min
- 12. Hot H<sub>3</sub>PO<sub>4</sub>, 170°C, 35 min
- 13. BHF Etch, 10:1, 1.5 min
- 14. RCA Clean
- 15. Wet Oxidation, 900 °C, 20 min
- 16. BHF Etch, 10:1, 1 min
- 17. RCA Clean
- 18. Wet Pad Oxidation, 900 °C, 15 min
- 19. Implant, Boron, 9×10<sup>11</sup>, 70KeV
- 20. BHF Etch, 10:1, 2min
- 21. RCA Clean
- 22. Anneal, 950 °C, 30 min

#### • Buried Channel Formation

- 1. RCA Clean
- 2. Wet Pad Oxidation, 900 °C, 15 min
- 3. Photoresist Application
- 4. Prebake, 98 °C, 30 min
- 5. Mask Level BCN
- 6. Photoresist Development
- 7. Postbake, 120 °C, 30 min
- 8. Implant, Arsenic, 5×10<sup>11</sup>, 75KeV
- 9. Plasma Photoresist Strip (Oxygen)
- 10. Photoresist Stripper
- 11. Photoresist Application
- 12. Prebake, 98 °C, 30 min
- 13. Mask Level BCP
- 14. Photoresist Development
- 15. Postbake, 120 °C, 30 min
- 16. Implant, Boron,  $5 \times 10^{15}$ , 32 KeV
- 17. Plasma Photoresist Strip (Oxygen)

- 18. Photoresist Stripper
- 19. Photoresist Application
- 20. Prebake, 98 °C, 30 min
- 21. Mask Level IR
- 22. Photoresist Development
- 23. Postbake, 120 °C, 30 min
- 24. Implant, Phorsphorus, 5×10<sup>11</sup>, 100KeV
- 25. Plasma Photoresist Strip (Oxygen)
- 26. Photoresist Stripper
- 27. BHF Etch 10:1, 2 min

#### • Gate Dielectric Formation

- 1. RCA Clean
- 2. Triple Wall Dry Oxidation, 800 A, 900 °C
- 3. Photoresist Application
- 4. Prebake, 98 °C, 30 min
- 5. Mask Level MW
- 6. Photoresist Development
- 7. Postbake, 120 °C, 30 min
- 8. BHF Etch, 10:1, 2 min
- 9. Photoresist Stripper
- 10. RCA Clean
- 11. Triple Wall Dry Oxidation, 720 °C, 20 Å, 9 min
- 12. LPCVD Nitride, 250 mTorr, 735 °C, 120 Å, 5 min, 10:1
- 13. Wet Blocking Oxidation, 1000 °C, 40 Å, 50 min

#### • Gate Material

- 1. LPCVD Polysilicon, 800 mTorr, 180 sccm SiH $_4$ , 625 °C, 5000  $^{\rm A}$  , 30 min
- 2. RCA Clean
- 3. POCl<sub>3</sub> Doping, 900 °C, 25 min Pre-deposition, 30 min Drive-in
- 4. BHF Etch, 10:1, 15 sec.
- 5. Photoresist Application
- 6. Prebake, 98 °C, 30 min
- 7. Mask Level PY
- 8. Photoresist Development
- 9. Postbake, 120 °C, 30 min

- 10. Plasma Polysilicon/Gate Dielectric Etch (SF<sub>6</sub>)
- 11. BHF Etch, 100:1, 1 min
- 12. Hot H<sub>3</sub>PO<sub>4</sub> Etch, 170 °C, 3.5 min
- 13. BHF Etch, 100:1, 1 min
- 14. Photoresist Stripper

#### • Source/Drain Formation

- 1. RCA Clean
- 2. Dry Pad Oxidation, 900 °C, 200-300 Å, 15 min
- 3. Photoresist Application
- 4. Prebake, 98 °C, 30 min
- 5. Mask Level N+
- 6. Photoresist Development
- 7. Postbake, 120 °C, 30 min
- 8. Source/Drain Implant, Phorsphorus, 2×10<sup>15</sup>, 100KeV
- 9. Plasma Photoresist Strip (Oxygen)
- 10. Photoresist Stripper
- 11. Photoresist Application
- 12. Prebake, 98 °C, 30 min
- 13. Mask Level P+
- 14. Photoresist Development
- 15. Postbake, 120 °C, 30 min
- 16. Source/Drain Implant, Boron, 5×1015, 30KeV
- 17. Plasma Photoresist Strip (Oxygen)
- 18. Photoresist Stripper
- 19. RCA Clean without HF Dip
- 20. Anneal and Drive-in, 950 °C, 60 min
- 21. BHF Etch, 10:1, 1 min

#### • Contact Window Formation

- 1. RCA Clean
- 2. Wet Oxidation, 900 °C, 1000 Å, 30 min
- 3. Photoresist Application
- 4. Prebake, 98 °C, 30 min
- 5. Mask Level CW
- 6. Photoresist Development

- 7. Postbake, 120 °C, 30 min
- 8. BHF Etch, 10:1, 3-5 min
- 9. Photoresist Stripper
- 10. Dilute HF Etch (HF Dip), 30 sec

#### • Metallization

- 1. RF Sputtering Aluminum, 110 mTorr, 60 min
- 2. Photoresist Application
- 3. Prebake, 98 °C, 30 min
- 4. Mask Level MET
- 5. Photoresist Development
- 6. Postbake, 120 °C, 30 min
- 7. PAN Etch, 45 °C, 2 min
- 8. Photoresist Stripper
- 9. Backside Clean-up
- 10. Backside RF Sputtering Aluminum, 110 mTorr, 60 min
- 11. Preliminary Check ensuring contact window open
- 12. Organic Clean
- 13. PMA, 450 °C, 30 min

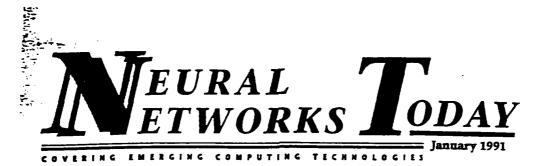
#### Appendix B

#### List of Publication

- Yin Hu, William Wagner, and Marvin H. White, "Characterization of a Novel Buried Channel EEPROM NVSM", Proceedings of the 12th IEEE Nonvolatile Semiconductor Memory (NVSM) Workshop, Monterey, August 1992.
- Margaret L. French, Chun-Yu Chen and Marvin H. White, "New Results on Scaled SONOS Nonvolatile Memory Devices", Proceedings of the 12th IEEE Nonvolatile Semiconductor Memory (NVSM) Workshop, Monterey, August 1992.
- Chun-Yu Malcolm Chen, Marvin H. White and Margaret French, "A Solid-State Electronic Linear Adaptive Neuron with Electrically Alterable Synapses", Proceedings of the 1991 International Joint Conference on Neural Networks, Singapore, November 1991.
- Chun-Yu Malcolm Chen, Marvin H. White and Margaret French, "A Solid-State Electronic Linear Adaptive Neuron with Electrically Reprogrammable Synapses", Proceedings of the Electro/91 International Electronics Conference and Exposition, New York, April 1991.
- Chun-Yu Malcolm Chen, Margaret French and Marvin H. White, "An Analog Nonvolatile Electrically Modifiable Synaptic Element for VLSI Neural Network Implementation", Proceedings of the 1991 IEEE Nonvolatile Semiconductor Memory Workshop, Monterey, February 1991.
- Chun-Yu Malcolm Chen, Marvin H. White and Margaret French, "A Single-level Two Tap Weight Linear Adaptive Neuron with Electrically Modifiable Synapses", Proceedings of the 1990 Long Island IEEE Student Conference on Neural Networks, Long Island, April 1990.

#### Media Coverage

From Neural Network Today, January, 1991



# **DARPA Funds Academics, Agencies, National Laboratories**

Academics funded by the Defense Advanced Research Projects Agency (DARPA) gave reviews of their work at the project update meeting last year, along with industry contractees, government laboratories and agencies such as the National Aeronautics and Space Administration's (NASA's) Jet

technologies, as well as theoretical advances.

One of the most aggressive efforts funded by DARPA is the modifiable synapse. Digital memories are ill-suited for storing the analog memory element used by neural networks which is why DARPA is

funding the futuristic quest for an analog memory unit.

Researcher Marvin White at Lehigh University (Bethlehem, Penn.) is attempting to create an electronic version of the synapse with a multi-delectric called the Sonos Continued on page 4

#### Neural Networks Call Bets at Horse-Race Track

#### DARPA Funds Academics, Agencies, National Labs mable synapses using chips with a

Continued from page 1 memory transistor. Sonos is an electricully-reprogrammable nonvoiatile method of adaptively changing the conductance of an analog syname. Compared with electricully-erasable programmable read-only memories (EEPROMs), it offers a low programming voltage (5 volts). Sonos also has low power dissipation, wide dynamic range and strong radiation hardness. Sonos can mimic biological synames with reinforcement learning and has stable long-term memory retention.

At the Massachusetts institute of Technology (MIT) investigator Alice Chiang is using charge-coupled devices (CCDs) as the analog memory element. MIT is developing a high-speed, low-power, general-purpose feature-extractor and classifier using neural technology. MIT's target applications are image- and speech-recognition. Chiang favors CCDs which can store analog levels of information in circulating bucket brigacies" with better than 99.999% charge transfer efficiency and greater than 45db dynamic range.

MIT selected a generic two-layer neural network classifier based on vector-matrix products for implementation. It can also be used for 1-D correlations and 2-D matched filters. Two versions of a microchip neural processor have been designed:

• 6144 connection classifier with 192 inputs and 32 outputs

The first version performs 2-D filtering of gray-level images with 20 programmable 7-by-7-by-8 bit sparial filters which can extract features from an input image in real-time. The 29 squares millimeter chip area consists of an analog imput buffer, 49 multiplying D/A converses and 20 7-by-7-by-8 bit local memories. The 10MHz device runs at one million antifunctic operations per second at less than 1 wart.

A second 49 square millimeter chip consists of analog input buffer, 144 Multipling to Digital Analog Conveness and 14 6-bit 144-element memories. The 10MHz device runs at 2.8 billion antimetic operations per second and consumes 2 wats. Future versions will be scaled up using similar chips in a parallel pipelined configuration. When mounted on boards, the chips can act as high-speed neural co-processors for conventional cligital processors.

NASA's Jer Propulsion Laboratory (Pasadena, Calif.) is investigating capacitors as the analog memory element in neural networks. Researcher Anil Thaixor at JPL reported on a project to evaluate the feasibility of using analog hardware to implement neural network learning methods. Their areas of interest cover speech, pattern- and target-recognition, senar, process control and prediction.

A .- --- ---- wereight by a 3.7.16.

mable synapses using chips with a capacitor remain scheme and 11-bit resolution. A neuron chip performs the sigmoid and provides variable gain. The network uses 36 neurons fabricated with CMCS castom VLSI microchips connected in a feedback configuration. Setting feedback to zero, for feedforward only, yields a network with eight inputs, eight outputs and 22 hidden users in up to 8 hidden layers.

Currently JPL is experimenting with learning that sequentially perturbs each synaptic weight under a computer control. The computer reads the error in the cumput from hardware to generate the control signal for the modifications of the weights. This architecture has been successfully tested on the inverse kinematics transformations in robotics and for recognition of terrain features areas spectral signatures.

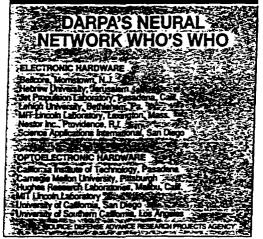
In Lincoin Lais adjacent to MIT, researcher Courosin Mehanian is designing an optical neural technology using a monoilithic opto-electronic transistor (MOET). A neuron consists of a multiple-quantum well (MQW) light detector on the inputs, a nonlinear resonant-tunneling diode and another MQW functioning as the output modulator. This optical neuron sums its inputs, performs a sigmoidal transformation and modulates the output optical beam. The intensity of the beam represents neural activity.

Lincoln Labs proposes building microchip arrays of sensing MOETs which can be assisted into the lavers

# DARPA LOOKING HARD AT NEURAL NETS.

it's getting more and more difficult to ignore neural networks. Just ask the Defense Department, whose Defense Advanced Research Projects Agency is going to spend \$33 million through 1992 to see if the networks can help solve signal-processing problems.

The lure of neural nets. which more or less armck problems the way the human brain does, is that they do not need complete data to solve complex problems-like a human they use context and a kind of intuition. And that plus massive parallelism and real-time



performance, acids up to more accuracy for missiles and increased maneuverability for tanks, ships, and aircraft. Whars more, there is evidence that neural nets degrade more gracefully and are easier to program than conventional ones.

Now. Darpa is funding a one-year effort at 50 companies, laboratories, and universities. They are working on neural simulation, theory, and modeling, with more than haif the effect devoted to simulating automatic target recognition and speech recognition, and sonar and seismic signal identification.

# HARDER TIMES IN **MASSACHUSETTS**

The widening Massachusetts malaise has finally infected Digital Equipment Corp., the Maynard, Mass., computer giant that had never had involuntary lavoits in its 33-year existence. And analysts believe the layoff of 3,500 that Digital announced last month may not be enough to stem a slump in മ്പന്നുട

Digital wants to mm its head count by 6,000 by the end of its riscal year, june 30. A voluntary retirement program fell some 3,500 short.

Digital still employs more than 120,000 worldwide and is the second largest employer in Massachusetts, behind Raytheon Co. But Digmi's downsizing will further out employment in the Bay State. which has lost some 200,000 jobs in the last year, most of them in the once-soaning computer and electronics the neural system. A stock-belt along the Boston areas price prediction takes 10 s. worth some \$130 million to eral says. stoned Route 129. II

#### ...AND HERE'S NEURAL COMPUTER THAT DOES 2.3 BILLION OPERATIONS/S

Defense Advanced Research Projects Agency seeds the neural network pastures, corporate researchers keep working on neural computers-machines, modeled on the human brain, that can handle tasks requiring intuition-though anything like commercial implementation is vears away. Now Hitachi Ltd. says it has come up with one whose learning processing unit that can handle 23 billion operations/s. 10 times what can be obtained by simulating a neural computer on an Hitachi 3-820 supercomputer.

The Hitachi lab model includes 1.152 neurons and is sust 12 m. high, 8.3 m. wide, and 9 in deep. The company has developed stock-price prediction and signature-versication applications that can be run on a workstation that is linked to says a Hitacra spokesman.

Even as the Pentagon's and a signature verification at least 1,000 interconnected takes 2 s.

The machine goes a long way toward overcoming faults of existing hardwarebased neural computers: they either bave too few neurons, or they learn too slowly. A practical system needs

neurons, say researchers at Himchi

The new computer is based on an LSI circuit announced in 1989 by Hitachi that houses 576 neurons. Eight of them are used in the new computer.

# AND THE WAS THE PARTY OF THE PA data general frosts 'Asparagus' i

the loss-odden Westboro, sand software for MII private Mass, computer manufacture data networks as ferming of the board transfer by manufacturery of directors firing of founder but it Data General. and chairman Edson de Cas- request, according to a tro Decronics, January 1991, Parry spokesman, p. 251 came the disclosure Tone reason. Belays that a once-promising coop reportedly slowed the erative venture into telecom- ject. The end came munications technology has joint evaluation by Data been scarled.

Corp. have plowed under and the market potential the "Asparagus" project, using current technology

\_\_\_\_

plague Data General Cop. State to develop hardware been scattled. eral and NIT of the particular form and Japan's NIT trans-network environment. 

SECTIONS - AND ATT IM

. . .

# LU scientists seek to speed up innovative neural net processe

- By JANINE CONNOR Science Writer

The lifestyle of the Jetsons is not that far from reality. Innovations familiar to our favorite future family, such as computers that can recognize handwriting, verify signatures, translate speech and drive cars already exist thanks to artificial neural networks.

Neural networking is a new information processing technique that is being researched to a great extent at Lehigh. It borrows its basic principles from biology, but is itself at the cutting edge of computer research.

Among those involved in this exciting field are Sherman-Fairchild professor of Computer Science and

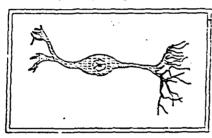
Electrical Engineering Marvin White graduate students Chun-Yu Malcolm Chen and Margaret French.

Chen, White and French are work to develop a device that has the abilit "learn" similar to the way people do.

But to do this means imitating the brain's 10-billion-neuron network, ar the extensive neural network of 200, nerves throughout the body.

"Individual neurons from our bodi are relatively slow compared to comp ers, but their network architecture me their processing fast," Chen said. The Lehigh researchers are trying to deve new structures to increase the speed

See NEURAL NETS Page 13



Neural net processing is modeled after biological networks of neural cells, wh form the basis of the learnin processes by transmitting signals to and from the brain

Tuesday, April 28, 1992

# **SciencePages**

# 13

# **NEURAL NETS**

From Page 11

anificial neural network structures.

The researchers at Sherman Fairchild Lab are developing a new type of solidstate electronic neuron with funds from the Defense Advanced Research Projects Agency (DARPA).

Lehigh, Massachusetts Institute of Technology and Hebrew University are the only schools that the DARPA Artificial Intelligence Neural Networks Technology Program supports financially in this specific area of technology. Fellowship support from the NSF Engineering Research Center for Advanced Technology for Large Structural Systems (ATLSS) is also contributing to the research.

"This research will be an ongoing project for many years," White said. "Right now we are in the embryonic stages."

"This is a fairly new field with a lot of new researchers," said Chen, who received his undergraduate and masters electrical engineering degrees from Lehigh and is now working on neural networks toward his Ph.D.

"We hope what we do will contribute to state of the art research regarding neural network technology," he said.

The artificial neural networks researchers are designing are contained in an electronic chip.

By applying different voltages, the scientists can train an electrical circuit to produce the correct output for changing input. In other words, the circuit "learns" how to respond based on its prior experiences.

The artificial neural networks developed at Sherman Fairchild Lab improve upon previous work by requiring a tow programming voltage of 5 volts and cutting down on loss of current. The system's small size and real-time application possibilities also make it attractive.

Chen said, "I am delighted to have the opportunity to work on this project because I think it has the potential to make a significant impact in the computer industry and signal processing field."

#### References

- 1. D.O. Hebb, The Organization of Behavior, John Wiley, 1949.
- 2. T. Kohonen, Associative Memory: A System Theoretic Approach, Springer-Verlag, 1977.
- 3. D. Rumelhart, and J. McClelland, Parallel Distributed Processing, MIT Press, 1986.
- 4. John J. Hopfield and David W. Tank, "Computing with Neural Circuits: A Model", Science, Vol. 233, August 1986, pp. 625-633.
- 5. J. Denker, "Neural Network for Computing: Snowbird 1986", AIP Conference Proceedings, 1986.
- 6. H.P. Graf and P. deVegvar, "A CMOS Implementation of a Neural Network Model", Proceedings of Stanford Conference on Advanced Research in VLSI, 1987.
- 7. Y. Tsividis and S. Satyanarayana, "Analog Circuits for Variable-Synapse Electronic Neural Networks", *Electronic Letters*, Vol. 23, No. 24, Nov 1987, pp. 1313-1314.
- 8. F.J. Kub, I.A. Mack, K.K. Moon, C.T. Yao and J.A. Modla, "Programmable Analog Synapses for Microelectronic Neural Networks Using a Hybrid Digital-Analog Approach", *IEEE Device Research Coference on Neural Networks*, 1988, pp. 24-27.
- 9. Mark Holler, Simon Tam, Hernan Castro, and Ronald Benson, "An Electrically Trainable Artificial Neural Network (ETANN) with 10240 'Floating Gate' synapses", *Proceedings of IJCNN*, 1989.
- 10. F.R. Libsch, A. Roy and M.H. White, "A True 5V EEPROM Cell for High Density NVSM", *IEEE Trans. Electron Devices*, Vol. ED-34, No. 11, 1987, pp. 2371.
- 11. M. White, D. Lampe, F. Blaha and I. Mack, "CCD and MNOS Devices for Programmable Analog Signal Processing and Digital Nonvolatile Memory", IEEE International Electron Devices Meeting, 1973.
- 12. M. White, D. Lampe, F. Kub, and D. Barth, "A Nonvolatile Charge Addressed Memory (NOVCAM) Cell", *IEEE. J. of Solid-State Circuits*, October 1975.
- 13. M.H. White, I.A. Mack, G.M. Borsuk, D.R.Lampe, and F.J. Kub, "Charge-Coupled Device (CCD) Adaptive Discrete Analog Signal Processing", *IEEE J. of Solid-State Circuits*, Vol. SC-14, 1979, pp. 132.
- 14. J. Sage and R. Withers and K. Thompson, "MNOS/CCD Circuits for Neural Network Implementation", *IEEE International Symposium on Circuits and Systems*, 1989, pp. 1207-1209.
- 15. B. Widrow and M. Hoff, Jr., "Adaptive Switching Circuits", IRE WESCON Conv. Rec., pt. 4, 1960, pp. 96.
- 16. M. White and I. Mack, A CCD Monolithic LMS Adaptive Analog Signal Processor Integrated Circuit, Final Report, Contract N00173-77-C-0328, 1980.
- 17. M. White, "A VLSI Conductance Multiplier (Synapse) for Hardware Implementation of Neural Networks", invited paper to workshop on Hardware Implementation of Neural Networks, 1988.
- 18. Chun-Yu Malcolm Chen, Margaret L. French and Marvin H. White, "An Analog Nonvolatile Eletrically Modifiable Synaptic Element for VLSI Neural Network Implementation", 11th IEEE Nonvolatile Semiconductor Memory Workshop, 1991.
- 19. A. Roy, F.R. Libsch, and M.H. White, "A Microcomputer-Controlled Multichannel Programmable Pattern Generator", *IEEE Transactions on Instrumentation and Measurement*, Vol. IM-36, No. 1, March 1987, pp. 96-99.

- 20. T.J. Kruisick, M.H. White, H.-S. Wong and R.V.H. Booth, "An Improved Method of MOSFET Modeling and Parameter Extraction", *IEEE Trans. on Electron Devices*, Vol. ED-34, No. 8, Aug. 1987, pp. 1676-1680.
- 21. Umesh Sharma and Marvin H. White, "Ionization Radiation Induced Degradation of MOSFET Channel Frequency Response", *IEEE Trans. on Nuclear Science*, Vol. 36, No. 3, June 1989, pp. 1359-1366.
- 22. Marvin H. White, Donald R. Lampe, Franklyn C. Blaha, and Ingham A. Mack, "Characterization of Surface Channel CCD Image Array at Low Light Levels", *IEEE J. of Solid-State Circuits*, Vol. SC-9, No. 1, February 1974, pp. 1-13.
- 23. J.L. Moschner, "Adaptive Filter with Clipped Input Data", Tech. report, Standford Lab. Report, No. 6796-1, June 1970.
- 24. Marvin H. White and Chun-Yu Chen, "Electrically Modifiable Nonvolatile Synapses for Neural Networks", Proceedings of IEEE International Symposium on Circuits and Systems, 1989, pp. 1213-1216.
- 25. Takaaki Nozaki, Toshiaki Tanaka, Yoshiro Kijiya, Eita Kinoshita, Tatsuo Tsuchiya, and Yutaka Hayashi, "A 1-Mb EEPROM with MONOS Memory Cell for Semiconductor Disk Application", *IEEE Journal of Solid-State Circuits*, Vol. 26, No. 4, April 1991, pp. 497-501.